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<text><text><list-item><list-item><list-item></list-item></list-item></list-item></text></text>	2	2. WORKMANSHIP STAND SOLDERING AND ELECT OR MORE CURRENT VE	ARD PER: IPC-J-STD-00 IRICAL COMNETIONS: RSIONS OF THESE STAN	1E, IPC-A-610E CLASS IPC-S-815B, IDARDS	52,		
 CLE LARSIS OF HER VARUE FROM THE TOP OF ASSEMUT. CLE LARSIS OF HER DECIDANCE DECIDENCE DE NAME HER INSCRIPTION OF ACTION OF THE STOCK OF THE STOCK	/?	∧ 3.∖ APPLY LABEL/LABELS W	ITH THE FOLLOWING IN	IFORMATION:) (NUMBER AND REV MUS	T MATCH THIS DRAWING)	04)
CONTRACT, DO CONTROLOND LAND STRUCTURE NUCLEONARIA DEBINERS. A CHA ASSMALT DE LA LAND NUCLEONALULT ISE DE INICICIONAL EST PER MACT TOTTSON 1000 SCIUD BOORT P2 SAME ASSMALT DE INICICIONAL EST PER MACT DE LA LAND NUCLEONALULT ISE DE INICICIONAL EST PER MACT DE LA LAND NUCLEONALULT ISE DE INICICIONAL EST PER MACT DE LA LAND NUCLEONALULT ISE DE INICICIONAL EST PER MACT DE LA LAND NUCLEONALULT ISE DE INICICIONAL EST PER MACT DE LA LAND NUCLEONALULT ISE DE INICICIONAL EST PER MACT DE LA LAND NUCLEONALULT ISE DE INICICIONAL EST PER MACT DE LA LAND NUCLEONALULT ISE DE INICICIONALULT ISE DE LA LAND NUCLEONALULT ISE DE INICICIONALULT ISE DE INICICIONA	/	PLACE LABELS SO THEY	ARE VISIBLE FROM THE	TOP OF ASSEMBLY.			
BUILDANGLE NOIS: NO COALINE REPORT AND LERING THE SEC. FCT 1500-1400 Send for 2.4dex • MANDACTURED FRESHELDE FRESHAURDER: • MANDACTURED CONSTRAINED FRESHAURDER • MANDACTURED CONSTRAINED AND BERMEIN HE IS CARACTORS SHOWN. • MANDACTURED CONSTRAINED AND BERMEIN HE IS CARACTORS SHOWN. • MANDACTORS SHOWN AND UP A TO METHED OF SO OFF RUMPS. SOLD TO PROOFS MISHING AND REPORT STUDENT HIS AND AND BERMEIN HE IS CARACTORS SHOWN. • MANDACTORS SHOWN AND UP A TO METHED OF SO OFF RUMPS. SOLD TO PROOFS MISHING PROVIDE AND CONTROL THE DEVELOPMENT OF TO METHED OF SOLD THE DOCTS MISHING AND THE STUDENT OF SUBJECT AND UP AT TO METHED OF SOLD THE DOCTS MISHING AND THE STUDENT AND UP AT TO METHED OF SOLD THE DOCTS MISHING AND THE STUDENT AND THE DIREL DRAWNED LATER OF THE DEVELOPMENT IS DO MANDACTOR TO DIRE AND CONTROL THE DIREL DRAWNED LATER OF THE DEVELOPMENT • MANDACTOR OFF ADD INSTALLED IN UPAL • MANDACTOR OFF ADD INTER OFF ADD INTER OFFICE IN	//	TOP SIDE NOTES: N	10 COATING ON J1 AI	nd J5 studs or con	INECTOR MATING SURFAC	0-001. (04) EES.	
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A PUT NOC CONCERNMENT MARKEN CONVERTS. MINUME BEAU DAY - SAMO. A CONTRACT CONVERTS. C CONVERS. C CONVERTS. C CONVER							
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	<u> </u>	MOMENTIVE RTV1	08 OR EQUIVALENT.				
10. PER MANUFACTURINO INSTALLED IN US. (B)	/9				of solder bumps. Solde	er process	
	1				G LAYER OF THE GERBERS.		
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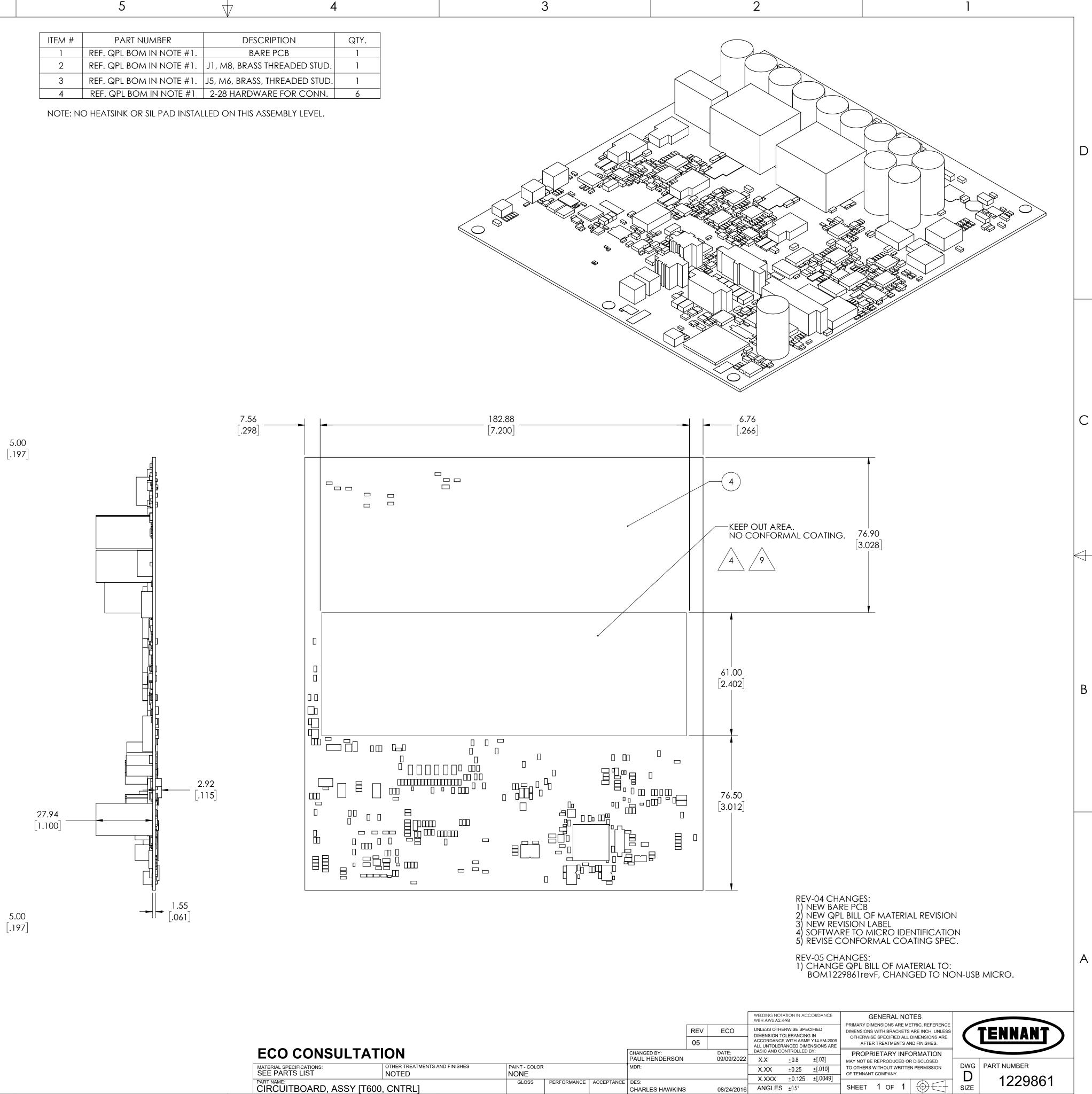
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ITEM #	PART NUMBER	DESCRIPTION	QTY.
1	REF. QPL BOM IN NOTE #1.	BARE PCB]
2	REF. QPL BOM IN NOTE #1.	J1, M8, BRASS THREADED STUD.	1
3	REF. QPL BOM IN NOTE #1.	J5, M6, BRASS, THREADED STUD.	1
4	REF. QPL BOM IN NOTE #1	2-28 HARDWARE FOR CONN.	6



	ECO CONSULTATION						CHANGE	
	MATERIAL SPECIFICATIONS: SEE PARTS LIST	OTHER TREATMENTS AND FINISHES		PAINT - COLOR NONE			PAUL HE	
	PART NAME: CIRCUITBOARD, ASSY [T600		GLOSS	PERFORMANCE	ACCEPTANCE	DES: CHARLE	Ξ	
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SHEET 1 OF 1

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